

Description

The HXY20N03D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =20A

 $R_{DS(ON)} < 25 m\Omega @ V_{GS} = 10V$

Application

Battery protection

Load switch Uninterruptible power supply

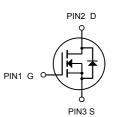
Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY20N03D	TO252-2L	20N03D XXX YYYY	2500

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	20	А
I _D @Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	15	А
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	7.3	А
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	5.8	А
Ідм	Pulsed Drain Current ²	50	А
EAS	Single Pulse Avalanche Energy ³	8.1	mJ
las	Avalanche Current	12.7	А
P _D @T _C =25°C	Total Power Dissipation ⁴	20.8	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R ₀ JA	Thermal Resistance Junction-ambient ¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹	6	°C/W





N-Channel MOSFET



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
∆BV _{DSS} /∆TJ	BVDSS Temperature Coefficient	Reference to 25°C , I₀=1mA		0.023		V/°C
		V _{GS} =10V , I _D =10A		18	25	
Rds(on)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =8A		25	38	mΩ
VGS(th)	Gate Threshold Voltage		1.0	1.2	2.5	V
$\bigtriangleup V_{\text{GS(th)}}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =250uA		-4.2		mV/°C
	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	
loss		V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA
lgss	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		5.5		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.3		Ω
Qg	Total Gate Charge (4.5V)			4.9		
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =10A		1.66		nC
Qgd	Gate-Drain Charge	-		1.85		
Td(on)	Turn-On Delay Time			1.6		- ns
Tr	Rise Time	V _{DD} =15V , V _{GS} =10V ,		15.8		
Td(off)	Turn-Off Delay Time	R _G =3.3 I⊳=10A		13		
T _f	Fall Time			4.8		
Ciss	Input Capacitance			416		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		62		pF
Crss	Reverse Transfer Capacitance	_		51		
ls	Continuous Source Current ^{1,5}				24	Α
lsм	Pulsed Source Current ^{2,5}	$-V_G=V_D=0V$, Force Current			50	A
Vsd	Diode Forward Voltage ²	V _{GS} =0V , Is=1A , TJ=25°C			1.2	V
trr	Reverse Recovery Time	IF=10A , dl/dt=100A/µs ,		8.7		nS
Qrr	Reverse Recovery Charge			1.95		nC
	J = 5		I			-

Electrical Characteristics (Tc=25°C unless otherwise specified)

Note :

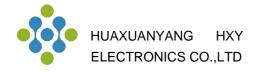
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2The data tested by pulsed , pulse width .The EAS data shows Max. rating .

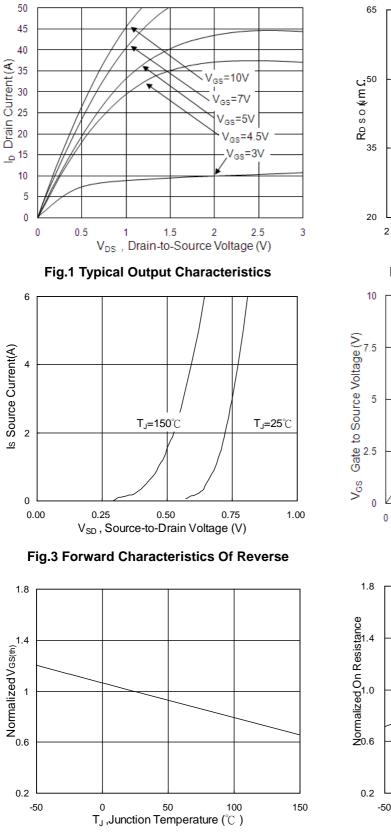
3he test condition is V \leq 300us , duty cycle _{DD=25} \leq V,V 2%_{GS} =10V,L=0.1mH,I_{AS}=12.7A

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as $I_{\text{\tiny D}}$ and $I_{\text{\tiny DM}}$, in real applications , should be limited by total power dissipation.



Typical Characteristics



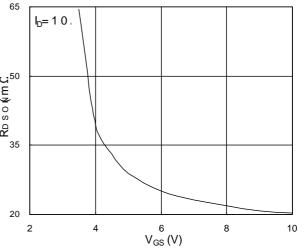


Fig.2 On-Resistance vs. Gate-Source

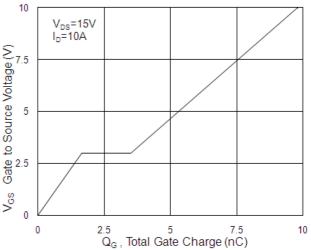


Fig.4 Gate-Charge Characteristics

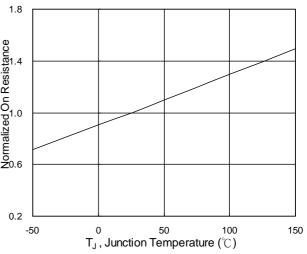


Fig.6 Normalized R_{DSON} vs. T_J

Fig.5 Normalized V_{GS(th)} vs. T_J



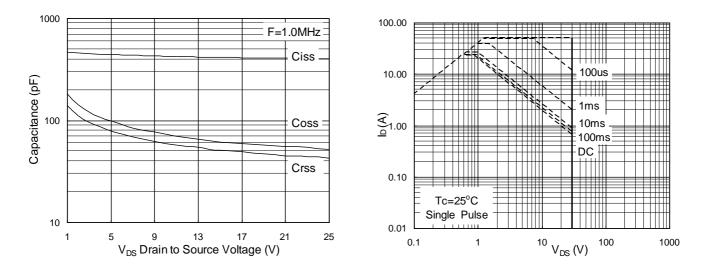


Fig.7 Capacitance

Fig.8 Safe Operating Area

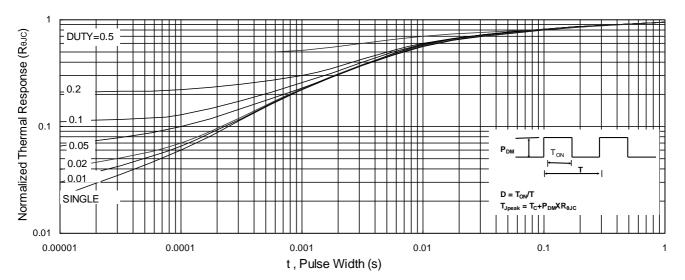


Fig.9 Normalized Maximum Transient Thermal Impedance

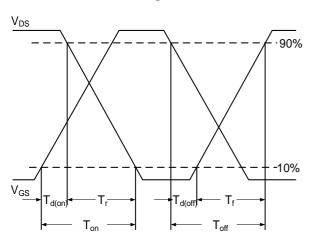


Fig.10 Switching Time Waveform

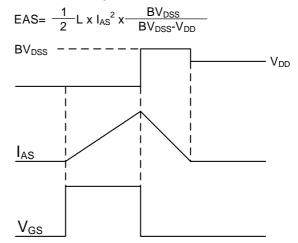
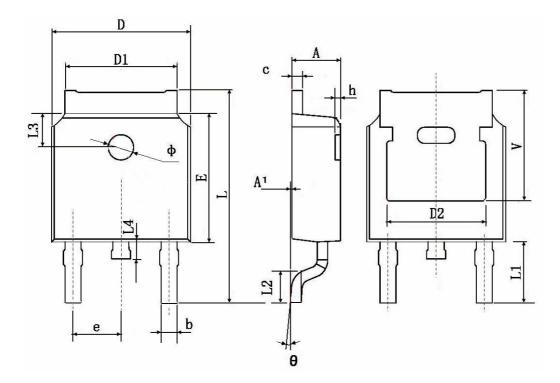


Fig.11 Unclamped Inductive Switching Waveform



TO252-2L Package Information



0 milest	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483	0.483 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	00 TYP. 0.063 TYP.		B TYP.	
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.21	1 TYP.	



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